



USER MANUAL

UP Series | Thermopile Power Detectors



WARRANTY

First Year Warranty

The Gentec-EO thermal power and energy detectors carry a one-year warranty (from date of shipment) against material and /or workmanship defects when used under normal operating conditions. The warranty does not cover recalibration or damages related to misuse.

Gentec-EO will repair or replace at its option any wattmeter or joulemeter which proves to be defective during the warranty period, except in the case of product misuse.

Any unauthorized alteration or repair of the product is also not covered by the warranty.

The manufacturer is not liable for consequential damages of any kind.

In the case of a malfunction, contact the local Gentec-EO distributor or nearest Gentec-EO office to obtain a return authorization number. Return the material to the appropriate address below.

Contacting Gentec Electro-Optics Inc.

To help us answer your calls more efficiently please have the model number of the detector you are using ready before calling Customer Support.

All customers:

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1. ULTRA SERIES UP POWER DETECTORS

1.1. INTRODUCTION

The Gentec-EO Ultra Series UP power detector family includes thirteen series (XLP12, UP12E, UP10K(P), UP17P, UP19K, UP25N(M), UP25T, UP50N(M), UP55N(M), UP55C, UP60N(M), UP55G, and UP60G) of opto-thermal sensors with different cooling options (stand alone, heat sink, fan and water), with or without amplification. The high power surface absorber sensors are designed for use at high average power densities.

Unit	Aperture	Exterior dimensions	Power range
	mm	mm	(without amplification)
XLP12	12	73 x 73	1 μW to 3 W
UP10P	10	46 x 46	0.1 mW to 2 W
UP10K	10	50 x 50	0.1 mW to 2 W
UP12E	12	38 x 38	1 mW to 70 W
UP17P	17	46 x 46	1 mW to 6 W
UP16K-XX-XX-QED	16	50 x 50	0.2 mW to 200 W
UP19K-XX-XX-VR	18	50 x 50	0.2 mW to 200 W
UP19K-XX-H5/H9/W5	19	50 x 50	0.2 mW to 200 W
UP25N(M)	25	89 x 89	3 mW to 350 W
UP25T	25	62.4 x 62.4	10 mW to 250 W
UP50N(M)	50	89 x 89	5 mW to 50 W
UP52N(M), UP55N(M)	52 ; 55	89 x 89	5 mW to 700 W
UP55G	55	120 x 120	15 mW to 600 W
UP55C	55	116 X 116	0.2 W to 2500 W
UP60N(M)	60	89 x 89	5 mW to 700 W
UP60G	60	120 x 120	15 mW to 600 W

The UP detectors are supplied with a 180 cm length flexible cable with output connection options of a DB-15 "intelligent" male connector, an Integra USB connector, a BNC connector, a Molex connector and a BNC/Molex connector. A few exception exist: the UP50N series is available with BNC/Molex connector on special order only and the XLP12, UP60N(M), and UP60G series are only supplied with a DB-15 "intelligent" male connector and the Integra USB connector.

Fan-cooled UP detectors are supplied with a 320 cm length flexible power cable.

NOTE: To eliminate possible damage, do not carry the detector using the connector cable.

The UP detectors may also be supplied with a stand. Be aware that when using a detector with a heat sink, the fins should always be placed vertically.

For cases where Gentec-EO's monitors don't automatically read the wavelength correction factor, you can use your detector's "Personal wavelength correctionTM Certificate" to adjust the power you read to a power corrected for a particular wavelength.

Call your nearest Gentec-EO distributor to replace the sensor disk and/or to recalibrate the head. For Gentec-EO's nearest office contact information, see p. ii, **Contacting Gentec Electro-Optics Inc.**

1.2. POWER DETECTOR CONNECTORS

1.2.1. DB-15 "intelligent" connector

The DB-15 male "intelligent" connector contains an EEPROM (Electrically Erasable Programmable Read-Only Memory) with different information such as the model of the detector, the calibration sensitivity, the applicable scales and the wavelength correction factor for up to 20 wavelengths related to the Ultra Series UP detector head in use.

This connector, available in the UP without amplification, allows the TPM-300CE, DUO (model of the detector, calibration sensitivity and scale), U-LINK, SOLO and MAESTRO (model of the detector, calibration sensitivity, scale and wavelength correction factor) monitors to adjust their characteristics automatically to the power sensor being connected. No calibration procedure is required when installing the power heads, allowing for faster set-up.

The DB-15 connector pin-out is composed of (see Fig. 1-1):

```
1-
        USED BY MONITOR
 2-
 4-
 5-
        SIGNAL (+)
 6-
 7-
        USED BY MONITOR
 8-
 9-
10-
11-
12-
13-
        SIGNAL (-)
14-
        USED BY MONITOR
15-
```

SHELL - BODY GROUND

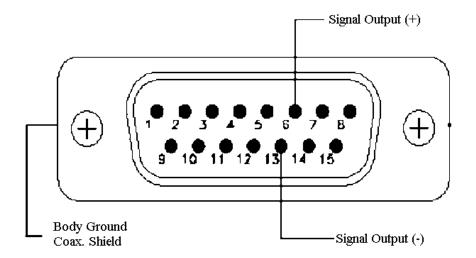


FIG. 1-1 DB-15 CONNECTOR PIN-OUT

1.2.2 Integra USB connector

The Integra USB Connector is an integrated monitor that allows to plug the head directly into a computer. It has the same serial commands as the MAESTRO and a few extra one's (see the PC-Gentec-EO Manual) and uses the same PC-Gentec-EO software. All specifications are mostly the same, except for:

Wattmeter and joulemeter heads have a noise ~1.3 x higher. The risetime of the UP12 head (with anticipation) is slower by 0.2 seconds.

1.2.3 BNC connector

The BNC connector is quick and easy to install and is the best at shielding EMI noise.

The BNC connector allows you to connect the detector directly on an oscilloscope or to a precision microvoltmeter with the correct load impedance. The connector is available in the UP detectors without amplification (load impedance: $100 \text{ k}\Omega$) and with the Molex connector in the amplified version (load impedance: $10 \text{ M}\Omega$).

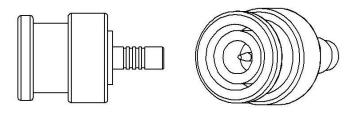


FIG. 1-2 BNC CONNECTOR

1.2.2. OEM Molex connector (E0 version)

The Molex female connector is available in the UP19-xxx-H5 and UP12E-xxx-H5 without amplification (load impedance : 100 k Ω). It allows you to connect to an external PCB board available at Gentec-EO.



FIG. 1-3 MOLEX CONNECTOR PIN-OUT IN E0 VERSION

1.2.3. Molex connector (MT version)

The Molex male connector, available in the UP with amplification, allows you to power the internal circuit board (PCB) and to read the signal with your own electronics.

The PCB needs +12 to +16V from a regulated power supply but **does not** need negative voltage.



FIG. 1-4 MOLEX CONNECTOR PIN-OUT IN MT VERSION

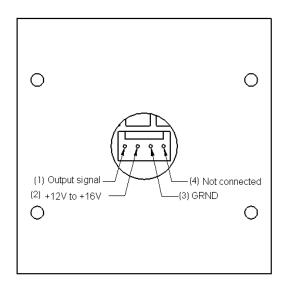


FIG. 1-5 MOLEX CONNECTOR PIN-OUT IN MT-B VERSION

Make your own molex cable for use with OEM heads. Product number: 202170



FIG. 1-6 FEMALE MOLEX CONNECTOR KIT FOR MT AND MO VERSIONS

1.2.4. Molex-BNC (BT version)

The Molex-BNC connection, available in the UP with amplification, allows you to power the internal circuit board (PCB) with the Molex connector and to read the signal with the BNC connector (load impedance : 10 $M\Omega$). The PCB needs +12 to +16V from a regulated power supply but **does not** need negative voltage.

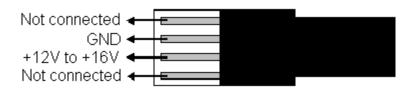


FIG. 1-7 MOLEX CONNECTOR PIN-OUT IN BT VERSION

1.2.5. Molex connector without amplification or anticipation (M0 version)

The Molex male connector, available in the UP without amplification, allows you to read the signal with your own electronics.

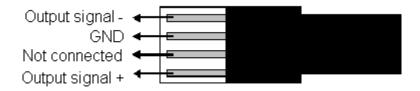


FIG. 1-8 MOLEX CONNECTOR PIN-OUT IN M0 VERSION

1.3. ULTRA SERIES UP, XLP SERIES SPECIFICATIONS

The following specifications are based on a one-year calibration cycle, an operating temperature of 15 to 28°C and a relative humidity not exceeding 80%. Storage 10 to 65°C and relative humidity not exceeding 90%.

Water quality requirements (for water-cooled detector)

- The diameter of the particule in the water must be below 60µm. (Gentec-eo can provide an external water filter 202990 if water quality is an issue)
- The resistivity of the water must be over 100 kOhm-cm.
- The hardness must be below 10ppm.
- The PH must be between 6.0 to 8.0. (Low PH will remove the protective oxide layer)

XLP123S-H2	XLP12-	3S -H2	XLPF12	-3S -H2
Effective Aperture Diameter	12 n		mm	
Spectral Range	0.19 µm	– 20 μm	0.28 μm -	
Calibrated spectral range ^a	0.248 -	2.1 µm	0.308 – 2	2.1 µm ^b
Available Extra Calibrated Ranges °	2.1 µm - 2.5 µr	m <u>OR</u> 10.6 μm	-	
Power Noise Level d, e		± 0.5	5 μW	
Thermal Drift f	12 μ\	N/°C	6 µW	//°C
Typical Rise time (0-95%)		27 s (2.5 s wit	h anticipation)	
Typical sensitivity	200 n	ηV/W	180 m	ıV/W
Calibration Uncertainty ^g		± 2.	5 %	
Linearity with Power		± 2	2 %	
Repeatability (Precision)		± 0.	5 %	
Max. Average Power		3	W	
Max. Average Power (1 min) (cooling : minimum 3 min)	3 W			
Max. Average Power Density 1.064 µm, 1 W CW		1 kW	//cm ²	
Pulsed Laser Damage Thresholds	Max. Energ	gy Density	Peak Powe	er Density
1.064 µm, 360 µs, 5 Hz	5 J/c		14 kW	
1.064 µm, 7 ns, 10 Hz	1 J/c		143 M\	
532 nm, 7 ns, 10 Hz	0.6 J		86 MV	.,
266 nm, 7 ns, 10 Hz	0.3 J		43 MV	
Dimensions (H x W x D, in mm)	With isol. tube: 73 x 73 x 72	W/o isol. tube: 73 x 73 x 20	With isol. tube: 73 x 73 x 80	W/o isol. tube: 73 x 73 x 28
Weight (head only, with isolation tube)	0.312 kg		0.324	4 kg
Cooling	Heat sink			
Recommended load Impedance	100 kΩ			
Output Impedance	N. A.			
Linearity vs beam dimension	± 0.7 %			
Power supply range (VDD)	N. A.			
Max output signal		N.	A.	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

^b Except 1350 – 1450 nm.

 $^{^{\}text{c}}$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 µm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

^d Nominal value, actual value depends on electrical noise in the measurement system.

 $[^]e$ Without anticipation. \pm 5 μW with anticipation. f At 150 μW . 12 $\mu W/^\circ C$ for XLP12 with SOLO, 50 $\mu W/^\circ C$ for XLP12 with P-LINK.

^g Including linearity with power

123S-VP	XLP12-3S -VP	
Effective Aperture Diameter	12 mm	
Spectral Range	0.248 -	– 20 µm
Calibrated spectral range ^a	0.248 -	- 2.1 μm
Available Extra Calibrated Ranges ^b	2.1 µm - 2.5 µ	m <u>OR</u> 10.6 μm
Power Noise Level c, d	± 0.9	5 μW
Thermal Drift ^e	12 μ	W/°C
Typical Rise time (0-95%)	30 s (3.0 s wi	th anticipation)
Typical sensitivity	220 ו	mV/W
Calibration Uncertainty f		ያ 1.064μm 0.25-2.5μm
Linearity with Power		2 %
Repeatability (Precision)	± 0.	.5 %
Max. Average Power	3 W	
Max. Average Power (1 min) (cooling : minimum 3 min)	3 W	
Minimum Repetition Rate	7 Hz with Antipation 1 Hz without Anticipation	
Max. Average Power Density 1 W CW 30 W/cm2 @1.064 8 W/cm2 @0.532 µ 4 W/cm2 @0.355 µ		@0.532 μm
Pulsed Laser Damage Thresholds	Max. Energy Density	
1.064 µm, 7 ns, 10 Hz	4 J/cm ²	
532 nm, 7 ns, 10 Hz	3 J /cm ²	
355 nm, 7 ns, 10 Hz	1 J /cm ²	
Dimensions (H x W x D, in mm)	With isol. tube: W/o isol. tube: 73 x 73 x 72 73 x 73 x 20	
Weight (head only, with isolation tube)	0.316 kg	
Cooling	Heat sink	
Recommended load Impedance	100 kΩ	
Output Impedance	N. A.	
Linearity vs beam dimension	± 0.7 %	
Power supply range (VDD)	N. A.	
Max output signal	N. A.	

^aThe traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $[^]b$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 μm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

^c Nominal value, actual value depends on electrical noise in the measurement system.

 $[^]d$ Without anticipation. $\pm\,5\,\mu\text{W}$ with anticipation. e At 150 $\mu\text{W}.\,$ 12 $\mu\text{W}/^e\text{C}$ for XLP12 with SOLO, 50 $\mu\text{W}/^e\text{C}$ for XLP12 with P-LINK.

f Including linearity with power

UP(F)10P-2S-H5-L	UP10P-2S-H5-L	UPF10P-2S-H5-L	
Effective Aperture Diameter	10 mm		
Spectral Range	0.19 – 20 μm	0.28 μm – 2.1 μm	
Calibrated spectral range ^a	0.248 – 2.1 μm	0.308 – 2.1 μm ^c	
Available Extra Calibrated Ranges ^b	2.1 μm - 2.5 μm <u>OR</u> 10.6 μm	-	
Power Noise Level	0.2 mW with anticipation 0.1 mW without anticipation 30 μ W with anticipation and moving average mode (2 sec)		
Typical Rise time (0-95%)	3.0 s (1.4 s with	n anticipation)	
Typical sensitivity	2 mV/W	1.8 mV/W	
Calibration Uncertainty ^e	± 2.5	%	
Linearity with Power	±2°	%	
Repeatability (Precision)	± 0.5	%	
Max. Average Power	2 S : 2	2 W	
Max. Average Power (1 min) (cooling : minimum 3 min)	2 S : 2 W		
Max. Average Power Density ^d 1.064 μm, 2W CW 10.6 μm, 2W CW	36 kW/cm² 11 kW/cm²		
Pulsed Laser Damage Thresholds 1.064 μm, 360 μs, 5 Hz 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	Max. Energy Density 5 J/cm² 1.0 J/cm² 0.6 J /cm² 0.3 J /cm²	Peak Power Density 14 kW/cm² 143 MW/cm² 86 MW/cm² 43 MW/cm²	
Dimensions (mm)	46(H) x 46(W) x 13(D)	46(H) x 46(W) x 21.4(D)	
Weight (head only)	2S : 0.13 kg	2S : 0.14 kg	
Cooling	Stand alone		
Recommended load Impedance	100 kΩ		
Output Impedance	N. A.		
Linearity vs beam dimension	± 0.7 %		
Power supply range (VDD)	N. A.		
Max output signal	N. A.		

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth

at 248 nm. b Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 μm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them. $^{\circ}$ Except 1350 - 1450 nm. d See graph at the end of this section.

e Including linearity with power

UP(F)10K-2S-H5-L	Without PCB	With PCB	
Effective Aperture Diameter	10	mm	
Spectral Range	UP10K : 0.19 – 20 μm UPF10K : 0.28 μm – 2.1 μm		
Calibrated spectral range ^a		.48 – 2.1 μm 308 – 2.1 μm °	
Available Extra Calibrated Ranges ^b	UP10K : 2.1 μm - 2.5 μm <u>OR</u> 10.6 μm		
Power Noise Level	0.2 mW with anticipation 0.1 mW without anticipation 30 μW with anticipation and moving average mode (2 sec)	0.2 mW with anticipation 0.1 mW without anticipation	
Typical Rise time (0-95%)	3.0 s (1.1 s wi	th anticipation)	
Typical sensitivity	UP10K : 2 mV/W UPF10K :1.8 mV/W	2 V/W	
Calibration Uncertainty e	± 2.5 %		
Linearity with Power	± 2	2 %	
Repeatability (Precision)	± 0.5 %		
Max. Average Power	2 S:	2 W	
Max. Average Power (1 min) (cooling : minimum 3 min)	2 S:	2 W	
Max. Average Power Density ^d 1.064 μm, 2W CW 10.6 μm, 2W CW	36 kW/cm² 11 kW/cm²		
Pulsed Laser Damage Thresholds 1.064 μm, 360 μs, 5 Hz 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	Max. Energy Density 5 J/cm² 1.0 J/cm² 0.6 J /cm² 0.3 J /cm²	Peak Power Density 14 kW/cm² 143 MW/cm² 86 MW/cm² 43 MW/cm²	
Dimensions (mm)	UP10K : 50(H) x 50(W) x 21.5(D) UPF10K : 50(H) x 50(W) x 30(D)	UP10K : 50(H) x 50(W) x 27(D) UPF10K : 50(H) x 50(W) x 35(D)	
Weight (head only)	UP10K : 0.13 kg UPF10K : 0.14 kg	UP10K : 0.20 kg UPF10K : 0.21 kg	
Cooling	Stand alone	Stand alone	
Recommended load Impedance	100 kΩ	10 ΜΩ	
Output Impedance	N. A.	≤ 50 Ω	
Linearity vs beam dimension	± 0.	7 %	
Power supply range (VDD)	N. A.	+ 12 V to + 16 V regulated	
Max output signal	N. A.	VDD (supply)-3V, max of 12V	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $^{^{}b}$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and

^{10.6} μm calibration added to a single detector. Contact a Gentec-EO representative to learn more

about these calibration options or get a quote for them. The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

Except 1350 – 1450 nm.

d See graph at the end of this section.

e Including linearity with power

UP12EH5	10S / 20H / 70W -H5	10S -H5
	Without PCB	With PCB
Effective Aperture Diameter Spectral Range	12 mm 0.19 – 20 μm	
Calibrated spectral range ^a		- 20 μm - 2.1 μm
Available Extra Calibrated	0.246	- 2. i µiii
Ranges b	2.1 μm - 2.5 μ	ım <u>OR</u> 10.6 μm
Power Noise Level	2 mW with anticipation 1 mW without anticipation	0.5 mW with anticipation ^e 0.25 mW without anticipation ^e
Typical Rise time (0-95%)	1.6 s (0.3 s with anticipation)	0.3 s (with anticipation)
Typical Nise time (0-93%) Typical sensitivity	0.53 mV/W	400 mV/W
Calibration Uncertainty f		.5 %
,		
Linearity with Power		2 %
Repeatability (Precision)		.5 %
Mary Assessed December	10S : 10 W	10S : 10 W
Max. Average Power	20H : 20 W	
	70W : 70 W	
Max. Average Power (1 min)	10S : 20 W	10S : 20 W
(cooling : minimum 3 min)	20H : 40 W	
`	70W : 110 W	
Max. Average Power Density ^c		2
1.064 µm, 10W CW	36 kW/cm ²	
10.6 μm, 10W CW	11 kW/cm ²	
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density
1.064 μm, 360 μs, 5 Hz	5 J/cm ²	14 kW/cm ²
1.064 µm, 7 ns, 10 Hz	1.0 J/cm ²	143 MW/cm ²
532 nm, 7 ns, 10 Hz	0.6 J /cm ²	86 MW/cm ²
266 nm, 7 ns, 10 Hz	0.3 J /cm ²	43 MW/cm ²
	10S : 38(H) x 38 (W) x 14 (D)	
Dimensions (mm)	20H : 38(H) x 38 (W) x 45 (D)	10S : 38(H) x 38 (W) x 36.6 (D)
` ,	70W : 38(H) x 38 (W) x 32 (D)	
	10S : 0.13 kg	
Weight (head only)	20H : 0.15 kg	10S : 0.20 kg
3 (70W : 0.19 kg	
Minimum Cooling Flow d	0.5 liter/min	N. A.
Recommended Cooling Flow d	1.0 liter/min	N. A.
Cooling	Heat sink / water	Stand alone
Recommended load Impedance	100 kΩ	10 ΜΩ
Output Impedance	N. A.	≤ 50 Ω
Linearity vs beam dimension	± 0.7 %	
,		
Power supply range (VDD) Max output signal	N. A. N. A.	+ 12 V to + 16 V regulated VDD (supply)-3V, max of 12V

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm. b Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and

^{10.6} μm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

[°] See graph at the end of this section.

d Water temperature ≤ 22°C, 1/8 NPT compression fittings for 1/4 inch semi-rigid tube.

^e Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

f Including linearity with power

UP16KQED UP16K-15S / 30H / 100W-QED Without PCB		
Effective Aperture Diameter	William Co.	
Spectral Range	0.2	266 - 2.5 μm
Calibrated spectral range		532 – 2.1 µm
Available Extra Calibrated Ranges ^a	2.1	μm - 2.5 μm
Power Noise Level		with anticipation ithout anticipation
Typical Rise time (0 - 95 %)	7 s (2.5 s	s with anticipation)
Typical sensitivity	0	0.11 mV/W
Calibration Uncertainty ^c		± 2.5 %
Linearity with Power		±2%
Repeatability (Precision)		± 0.5 %
Max. Average Power	3 10	15S : 15 W 30H : 30 W 10W : 100 W
Max. Average Power (1 min.) (cooling : minimum 3 min)	15S : 20 W 30H : 35 W 100W : 100 W	
Max. Average Power Density 1.064µm, 10W CW	10	00 kW/cm ²
Pulsed Laser Damage Thresholds 1,064 μm, 360 μs, 5 Hz 1,064 μm, 7 ns, single shot 1,064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	Max. Energy Density 300J/cm² 16 J/cm² 8 J/cm² 6 J/cm² 1 J/cm²	Peak Power Density 830kW/cm² 2280 MW/cm² 1140 MW/cm² 860 MW/cm² 143 MW/cm²
Mininum cooling flow ^b	0	.5 liter/min
Recommended cooling flow ^b	1	.0 liter/min
Dimension (mm)	15S : 50(H) x 50(W) x 23.6(D) 30H : 50(H) x 50(W) x 59.3(D) 100W : 50(H) x 50(W) x 36 (D)	
Weight (head only)	15S : 0.16 kg 30H : 0.21 kg 100W : 0,24 kg	
Cooling	Heat sink / water	
Recommended load Impedance	100 kΩ	
Output Impedance	N. A.	
Linearity vs beam dimension	± 0.5 %	
Power supply range (VDD)	N. A.	
Max outpul signal	N. A.	

^a The calibrations at 2.1 to 2.5 µm are on special request only and will incur additional charges. Contact a Gentec-EO representative to learn more about this calibration option or get a quote for it.

about this calibration option or get a quote for it.

b Water temperature ≤ 22°C, 1/8 NPT compression fittings for 1/4 inch semi-rigid tube.

^c Including linearity with power

UP17P-6S-H5	UP17P-6S -H5	
Effective Aperture Diameter	1	7 mm
Spectral Range	190 ni	m – 20 μm
Calibrated spectral range ^a	0.248	3 – 2.1 μm
Available Extra Calibrated Ranges ^b	2.1 μm - 2.5 μm <u>OR</u> 10.6 μm	
Power Noise Level ^c		th anticipation out anticipation
Typical Rise time (0-95%)	2.5 s (0.8 s	with anticipation)
Typical sensitivity d	0.6	6 mV/W
Calibration Uncertainty ^e	±	2.5 %
Linearity with Power	i	±2%
Repeatability (Precision)	±	0.5 %
Max. Average Power		6 W
Max. Average Power (1 min) (cooling : minimum 3 min)	7 W	
Max. Average Power Density ^f 1.064 μm, 10 W CW 10.6 μm, 10 W CW	36 kW/cm ² 11 kW/cm ²	
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density
1.064 µm, 360 µs, 5 Hz	5 J/cm ²	14 kW/cm²
1.064 µm, 7 ns, 10 Hz	1.0 J/cm ²	143 MW/cm ²
532 nm, 7 ns, 10 Hz	0.6 J /cm ²	86 MW/cm ²
266 nm, 7 ns, 10 Hz	0.3 J /cm ² 43 MW/cm ²	
Dimensions (mm)	46H x 46 (W) x 10.7 (D)	
Weight (head only)	0.1 kg	
Recommended load Impedance	100 kΩ	
Output Impedance	N.A.	
Linearity vs beam dimension	± 0.5 %	
Power supply range (VDD)	N.A.	
Max output signal		N.A.

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $^{^{\}text{b}}$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 µm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

Nominal value, actual value depends on electrical noise in the measurement system.

Maximum output voltage = sensitivity x maximum power

Including linearity with power

See graph at the end of this section

UP17P-6S-W5	UP17P-6S -W5	
Effective Aperture Diameter	17	mm
Spectral Range	190 nm	– 10 μm
Calibrated spectral range ^a	0.248 -	· 2.1 μm
Available Extra Calibrated Ranges ^b	2.1 μm ·	- 2.5 µm
Power Noise Level ^c		anticipation It anticipation
Typical Rise time (0-95%)	5 s (1.4 s with	n anticipation)
Typical sensitivity	0.6 m	nV/W
Calibration Uncertainty d	± 2.	5 %
Linearity with Power	± 2	2 %
Repeatability (Precision)	_	5 %
Max. Average Power	6	W
Max. Average Power (1 min) (cooling : minimum 3 min)	7 W	
Max. Average Power Density ^e 1.064 μm, 10 W CW	100 k\	W/cm ²
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density
1.064 μm, 150 μs, 5 Hz	100 J/cm ²	667 kW/cm ²
1.064 µm, 7 ns, 10 Hz	1.1 J/cm ²	157 MW/cm ²
532 nm, 7 ns, 10 Hz	1.1 J /cm ²	157 MW/cm ²
266 nm, 26 ns, 10 Hz	0.7 J /cm ² 27 MW/cm ²	
Dimensions (mm)	46(H) x 46(W) x 10.7(D)	
Weight (head only)	0.1 kg	
Recommended load Impedance	100 kΩ	
Output Impedance	N.A.	
Linearity vs beam dimension	± 0.5 %	
Power supply range (VDD)	N.A.	
Max output signal	N.A.	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth

^b The calibrations at 2.1 to 2.5 μm are on special request only and will incur additional charges. Contact a Gentec-EO representative to learn more about this calibration option or get a quote for it.

c Nominal value, actual value depends on electrical noise in the measurement system.

d Including linearity with power

e See graph at the end of this section

	15\$ / 30H / 50L / 100DI / 150W - H5	15S / 30H / 50L / 100DI / 110F / 150W -H5	
UP19KHx	15S / 110F / 150DI / 200W -H9 Without PCB	and 15S / 110F / 150DI / 200W -H9 With PCB	
Effective Aperture Diameter		mm	
Spectral Range		ı – 20 μm	
Calibrated spectral range ^a	0.248 -	– 2.1 μm	
Available Extra Calibrated Ranges ^b	2.1 µm - 2.5 µ	um <u>OR</u> 10.6 μm	
Power Noise Level	With anticipation H5 : 2 mW, H9 : 6 mW Without anticipation H5 : 1 mW, H9 : 3 mW	With anticipation H5 : 0.4 mW, H9 : 1.2 mW ^e Without anticipation H5 : 0.2 mW, H9 : 0.6 mW ^e	
Typical Rise time (0 - 95 %)	H5: 2.8 s (0.6 s with anticipation) H9: 4.5 s (1.5 s with anticipation)	H5: 0.5 s (with anticipation) H9: 1.5 s (with anticipation)	
Typical sensitivity	H5 : 0.65 mV/W H9 : 0.23 mV/W	15S-H5: 400 mV/W 15S-H9:: 200mV/W 30H: 200 mV/W 50L: 120 mV/W 100DI: 55 mV/W 100DI: 55 mV/W	
Calibration Uncertainty ^f	± 2	2.5 %	
Linearity with Power	±	2 %	
Repeatability (Precision)	± 0	0.5 %	
Max. Average Power	15S-H5, -H9 : 15 W 30H : 30 W 50L : 50 W 100DI (stainless steel) : 100 W	110F-H9: 110 W 150W: 150 W 150DI-H9 (stainless steel): 150 W 200W-H9: 200 W ^a	
Max. Average Power (1 min) (cooling : minimum 3 min)	15S-H5, -H9 : 30 W 30H : 60 W 50L : 90 W 100Dl (stainless steel) : 100 W	110F-H9 : 150 W 150W : 190 W 150DI-H9 (stainless steel) : 150 W 200W-H9 : 200 W ^a	
Max. Average Power Density ^c 1.064 μm, 10W CW 10.6 μm, 10W CW	H5 : 36 kW/cm ² , H9 : 45 kW/cm ² H5 : 11 kW/cm ² , H9 : 14 kW/cm ²		
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density	
1.064 µm, 360 µs, 5 Hz	H5 : 5 J/cm ² , H9 : 9 J/cm ²	H5 : 14 kW/cm ² , H9 : 25 kW/cm ²	
1.064 µm, 7 ns, 10 Hz	1.0 J/cm ²	143 MW/cm ²	
532 nm, 7 ns, 10 Hz	0.6 J /cm ²	86 MW/cm ²	
266 nm, 7 ns, 10 Hz	0.3 J /cm ²	43 MW/cm ²	
Dimensions (mm)	15S: 50(H) x 50(W) x 20.6(D) 30H: 50(H) x 50(W) x 56.3(D) 50L: 76.2(H) x 76.2(W) x 73.6(D) 100DI: 50(H) x 50(W) x 33(D) 110F: 50(H) x 50(W) x 62.8(D) 150W: 50(H) x 50(W) x 33(D) 150DI: 50(H) x 50(W) x 33(D) 200W: 50(H) x 50(W) x 33(D)	15S: 50(H) x 50(W) x 25.6(D) 30H: 50(H) x 50(W) x 61.3(D) 50L: 76.2(H) x 76.2(W) x 78.6(D) 100DI: 50(H) x 50(W) x 38(D) 110F: 50(H) x 50(W) x 67.8(D) 150W: 50(H) x 50(W) x 38(D) 150DI: 50(H) x 50(W) x 38(D) 200W: 50(H) x 50(W) x 38(D)	
Weight (head only)	15S: 0.16 kg 110F: 0.25 kg 30H: 0.21 kg 150W: 0.24 kg 50L: 0.48 kg 150DI: 0.42 kg 100DI: 0.42 kg 200W: 0.24 kg	15S: 0.20 kg 110F: 0.29 kg 30H: 0.25 kg 150W: 0.28 kg 50L: 0.52 kg 150DI: 0.46 kg 100DI: 0.46 kg 200W: 0.28 kg	
Minimum Cooling Flow ^d	0.5 li	ter/min	
Recommended Cooling Flow ^d	1.0 liter/min		
Cooling	Heat sink ,	/ fan / water	
Recommended load Impedance	100 kΩ	10 ΜΩ	
Output Impedance	N. A.	≤ 50 Ω	
Linearity vs beam dimension		0.5 %	
Power supply range (VDD)	N. A.	+ 12 V to + 16 V regulated	
Max output signal	N. A.	VDD (supply)-3V, max of 12V	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $[^]b$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and $10.6\ \mu m$ calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

^c See graph at the end of this section.

d Water temperature ≤ 22°C, 1/8 NPT compression fittings for ¼ inch semi-rigid tube. For the stainless steel water module, the minimum cooling flow is 1.0 liter/min for power higher than 90 W

Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

f Including linearity with power

UP19KVR	UP19K-15S / 30H -VR Without PCB			
Effective Aperture Diameter	18 mm			
Spectral Range	0.266 - 2.5 μm			
Calibrated spectral range	0.30 – 2.1 µm			
Available Extra Calibrated Ranges ^a	2.1 μm - 2.5 μm			
Power Noise Level	2 mW with	ith anticipation nout anticipation		
Typical Rise time (0 - 95 %)	,	with anticipation)		
Typical sensitivity		34 mV/W		
Calibration Uncertainty ^b	±	- 2.5 %		
Linearity with Power		± 2 %		
Repeatability (Precision)		- 0.5 %		
Max. Average Power	15S : 15 W 30H : 30 W			
Max. Average Power (1 min.)	15S : 20 W			
(cooling: minimum 3 min)	30H : 35 W			
Max. Average Power Density 1.064µm, 10W CW	700 W/cm ²			
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density		
1.064 µm, 7 ns, 10 Hz	6 J/cm ²	860 MW/cm ²		
532 nm, 7 ns, 10 Hz	4 J /cm ²	570 MW/cm ²		
266 nm, 7 ns, 10 Hz	1 J /cm ²	143 MW/cm ²		
1.064 µm, 360 µs, 10 Hz	40 J/cm ²	111 kW/cm ²		
Dimension (mm)		x 50(W) x 20.6(D) x 50(W) x 56.3(D)		
Weight (head only)	15S: 0.16 kg 30H: 0.21 kg			
Cooling	H	eat sink		
Recommended load Impedance	1	100 kΩ		
Output Impedance	_	N. A.		
Linearity vs beam dimension		± 0.5 %		
Power supply range (VDD)		N. A.		
Max outpul signal		N. A.		

^a The calibrations at 2.1 to 2.5 μm are on special request only and will incur additional charges. Contact a Gentec-EO representative to learn more about this calibration option or get a quote for it.

^b Including linearity with power

	UP19K-15S / 30H / 50L /	UP19K-15S / 30H / 50L /	
UP19KW5	50F / 50W / 50DI - W5	50F / 50W / 50DI - W5	
3. 13.1 113	Without PCB	With PCB	
Effective Aperture Diameter	19	mm	
Spectral Range		– 10 μm	
Calibrated spectral range ^a	0.248 – 2.1 μm		
Available Extra Calibrated	2.1 µm - 2.5 µm		
Ranges ^b	·	·	
Power Noise Level	2 mW with anticipation	0.4 mW with anticipation d	
Typical Rise time (0-95%)	1 mW without anticipation 5 s (1.4 s with anticipation)	0.2 mW without anticipation ^d 1.4 s (with anticipation)	
Typical Rise time (0-9378)	33 (1.43 with anticipation)	15 S : 400 mV/W	
		30H : 200 mV/W	
-	0.05	50L : 120 mV/W	
Typical sensitivity	0.65 mV/W	50F : 120 mV/W	
		50W : 120 mV/W	
		50DI : 120 mV/W	
Calibration Uncertainty ^e		5 %	
Linearity with Power		2.%	
Repeatability (Precision)		5 %	
		15 W	
Max. Average Power		30 W 50 W	
iviax. Average Fower		50 W	
		50 W	
		s steel): 50 W	
	,	30 W	
	30H :	60 W	
Max. Average Power (1 min)	50L : 85 W		
(cooling: minimum 3 min)		85 W	
		85 W	
Max. Average Power Density	50DI (Stainles	s steel): 85 W	
1.064 µm, 10 W CW	100 k ^v	W/cm ²	
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density	
1.064 µm, 150 µs, 10 Hz	100 J/cm ²	667 kW/cm ²	
1.064 μm, 7 ns, 10 Hz	1.1 J/cm ²	157 MW/cm ²	
532 nm, 7 ns, 10 Hz	1.1 J /cm ²	157 MW/cm ²	
248 nm, 26 ns, 10 Hz	0.7J /cm²	27 MW/cm ²	
	15S : 50(H) x 50(W) x 20.6(D) 30H : 50(H) x 50(W) x 56.3(D)	15S : 50(H) x 50(W) x 25.6(D) 30H : 50(H) x 50(W) x 61.3(D)	
	50L : 76.2(H) x 76.2(W) x 73.6(D)	50L : 76.2(H) x 76.2(W) x 78.6(D)	
Dimension (mm)	50F : 54.2(H) x 54.2(W) x 55.6(D)	50F : 54.2(H) x 54.2(W) x 60.6(D)	
	50W : 50(H) x 50(W) x 33(D)	50W : 50(H) x 50(W) x 38(D)	
	50DI : 50(H) x 50(W) x 33(D)	50DI : 50(H) x 50(W) x 38(D)	
	15S : 0.16 kg	15S : 0.20 kg	
	30H : 0.21 kg	30H : 0.25 kg	
Weight (head only)	50L : 0.48 kg	50L : 0.52 kg	
, , , , , , , , , , , , , , , , , , ,	50F : 0.25 kg 50W : 0.24 kg	50F : 0.29 kg 50W : 0.28 kg	
	50W : 0.24 kg 50DI : 0.42 kg	50W : 0.28 kg 50DI : 0.46 kg	
Minimum Cooling Flow ^c	· ·	er/min	
Recommended Cooling Flow °		er/min	
Cooling	Heat sink /		
Recommended load Impedance	100 kΩ	10 ΜΩ	
Output Impedance	N. A.	≤ 50 Ω	
Linearity vs beam dimension		5 %	
Power supply range (VDD)	N. A.	+ 12 V to + 16 V regulated	
Max output signal	N. A.	VDD (supply)-3V, max of 12V	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

ballowidth at 2-46 limi.

b The calibrations at 2.1 to 2.5 µm are on special request only and will incur additional charges. Contact a Gentec-EO representative to learn more about this calibration option or get a quote for it.

Water temperature ≤ 22°C, 1/8 NPT compression fittings for 1/4 inch semi-rigid tube.

^d Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

e Including linearity with power

LID25N/M) Hy	UP25N-40S / 100H -H9	UP25N-40S / 100H -H9			
UP25N(M)Hx-	UP25N-250F- H12	UP25N-250F- H12			
	UP25M-350W- H12	UP25M-350W- H12			
•••	Without PCB	With PCB			
Aperture Diameter	25 mm				
Spectral Range	190 nm - 20 μm				
Calibrated spectral range ^a	0.248 – 2.1 µm				
Available Extra Calibrated	24 25	OD 40 C			
Ranges ^b	2.1 μm - 2.5 μm <u>OR</u> 10.6 μm				
Power Noise Level	With anticipation H9 : 6 mW H12 : 20 mW Without anticipation H9 : 3 mW H12 : 10 mW	With anticipation 40S / 100H: 2 mW ° 250F-H12: 20 mW ° 350W-H12: 20 mW ° Without anticipation 40S / 100H: 1 mW ° 250F-H12: 10 mW ° 350W-H12: 10 mW °			
Typical Rise Time (0 – 95 %)	H9: 5 s (1.3 s with anticipation) H12: 7.9 s (1.3 s with anticipation)	H9: 1.3 s (with anticipation) H12: 2 s (with anticipation)			
Typical sensitivity	H9: 0.23 mV/W H12: 0.1 mV/W	40S-H9: 150 mV/W 100H-H9: 60 mV/W 250F-H12: 24 mV/W 350W-H12: 24 mV/W			
Calibration Uncertainty f	± 2.	5 %			
Linearity with Power	± 2	2 %			
Repeatability (Precision)	± 0.	5 %			
Max. Average Power	40S : 40 W 100H : 100 W 250F : 250 W 350W : 350 W				
Max. Average Power (1 min) (cooling : minimum 3 min)	100H: 250F:	80 W 200 W 300 W 350 W			
Max. Average Power Density ^c 1.064 μm, 10 W CW 10.6 μm, 10 W CW	45 kV	V/cm² V/cm²			
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density			
1.064 µm, 360 µs, 5 Hz	9 J/cm ²	25 kW/cm ²			
1.064 μm, 7 ns, 10 Hz	1.0 J/cm ²	143 MW/cm ²			
532 nm, 7 ns, 10 Hz	0.6 J/cm ²	86 MW/cm ²			
266 nm, 7 ns, 10 Hz	0.3 J/cm ²	43 MW/cm ²			
Dimension (mm)	100H : 89(H) x 250F : 89(H) x 3 350W : 89(H) x	89(W) x 116(D) 89(W) x 40(D)			
Aperture threading	Only from serial	0 (SM1) number 340900			
Weight (head only)	40S : 0.68 kg 100H : 0.99 kg 250F : 1.44 kg 350W : 0.87 kg				
Minimum Cooling Flow d		er/min			
Cooling	Heat sink /				
Recommended Load Impedance	> 100 kΩ	10 ΜΩ			
Output Impedance	N. A.	≤ 50 Ω			
Linearity vs Beam Dimension		5 %			
Power supply range (VDD)	N. A.	+12 V to +16 V regulated			
Max Outpul Signal	N. A.	VDD (supply)-3V, max of 12V			
		(

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $[^]b$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and $10.6~\mu m$ calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

[°] See graph at the end of this section.

d Water temperature ≤ 22°C, 1/8 NPT compression fittings for ¼ inch semi-rigid tube.

^e Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.
^f Including linearity with power

UP25THx	UP25T-15S / 250W- H12 Without PCB		
Aperture Diameter	25 mm		
Spectral Range	190 nm - 20 µm		
Calibrated spectral range ^a	0.248 – 2		
Available Extra Calibrated Ranges ^b	2.1 µm - 2.5 µm <u>OR</u> 10.6 µm		
Power Noise Level	20 mW with a 10 mW withou	t anticipation	
Typical Rise Time (0-95%)	7.9 (1.3 s with a	nticipation)	
Typical sensitivity	0.1 m	•	
Calibration Uncertainty ^e	± 2.5		
Linearity with Power	± 2°	%	
Repeatability (Precision)	± 0.5	5%	
Max. Average Power	15S : 1 250W : 2		
Max. Average Power (1 min.) (cooling : minimum 3 min)	15S : 15 W 250W : 250 W		
Max. Average Power Density ^c 1.064μm, 10W CW 10.6 μm, 10W CW	45 kW/cm² 14 kW/cm²		
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density	
1.064 µm, 360 µs, 5 Hz	9 J/cm ²	25 kW/cm ²	
1.064 µm, 7 ns, 10 Hz	1.0 J/cm ²	143 MW/cm ²	
532 nm, 7 ns, 10 Hz	0.6 J /cm ²	86 MW/cm ²	
266 nm, 7 ns, 10 Hz	0.3 J /cm ²	43 MW/cm ²	
Dimension (mm)	62.4(H) x 62.4(, , ,	
Weight (head only)	15S : 0. 250W : 0	1.33 kg	
Minimum Cooling Flow d	15S: Stan 250W: 1.5		
Cooling	15S: Stand alone 250W: water		
Recommended load Impedance	> 100	kΩ	
Output Impedance	N. A	٩.	
Linearity vs beam dimension	± 0.5	5 %	
Power supply range (VDD)	N. A	٩.	
Max outpul signal	N. A	٩.	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $^{^{\}text{b}}$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 µm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

[°] See graph at the end of this section.

d Water temperature ≤ 22°C, 1/8 NPT compression fittings for 1/4 inch semi-rigid tube.

e Including linearity with power

UP50N(M)W9-	UP50N-40S / 50H -W9	UP50N-40S / 50H -W9		
OF 3014(1VI)VV9-	UP50M-50W -W9	UP50M-50W -W9		
	Without PCB	With PCB		
Aperture Diameter	50	mm		
Spectral Range	190 nm	- 10 μm		
Calibrated spectral range ^a	0.248 -			
Available Extra Calibrated Ranges ^b	2.1 μm - 2.5 μm			
Power Noise Level	10 mW with anticipation 6 mW with anticipation d 5 mW without anticipation 3 mW without anticipation d			
Typical Rise Time (0 – 95 %)	16 s (3.5 s with anticipation)	16 s (3.5 s with anticipation)		
Typical sensitivity	0.12 mV/W	40S : 150 mV/W 50H : 120 mV/W 50W : 120 mV/W		
Calibration Uncertainty ^e	± 2.	5 %		
Linearity with Power	± 2	? %		
Repeatability (Precision)	± 0.	5 %		
	40S :	40 W		
Max. Average Power	50H : 50 W 50W : 50 W			
Max. Average Power	40S : 80 W			
(1 min.)	50H : 85 W			
(cooling : minimum 3 min)	50W : 85 W			
Max. Average Power Density 1.064μm, 10W CW	100 k\	W/cm ²		
Pulsed Laser Damage Thresholds	Max. Energy Density	Peak Power Density		
1.064 µm, 150 µs, 5 Hz	100 J/cm ²	667 kW/cm ²		
1.064 µm, 7 ns, 10 Hz	1.1 J/cm ²	157 MW/cm ²		
532 nm, 7 ns, 10 Hz	1.1 J /cm ²	157 MW/cm ²		
248 nm , 26 ns, 10 Hz	0.7J /cm ²	27 MW/cm ²		
_, , , ,	40S : 89(H) x 8			
Dimension (mm)	50H : 89(H) x 8			
	50W : 89(H) x			
Mariah (haradaah)	40S : 0			
Weight (head only)	50H : 0 50W : 0			
Minimum Cooling Flow ^c	1 lite	r/min		
Cooling	Heat sink /			
Recommended load Impedance	> 100 kΩ	10 ΜΩ		
Output Impedance	N. A.	≤ 50 Ω		
Linearity vs beam dimension	± 0.			
Power supply range (VDD)	N. A.	+12 to +16 V regulated		
Max outpul signal	N. A. VDD (supply)-3V, max of 12V			

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

^b Both options will incur additional charges. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

c Water temperature ≤ 22°C, 1/8 NPT compression fittings for ¼ inch semi-rigid tube.

^d Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

e Including linearity with power

UP52N(M)QED-	UP52N- 50S/100H/150F -QED UP52M- 300W -QED	UP52N -50S/100H/150F -QED UP52M -300W -QED		
	Without PCB	With PCB		
Aperture Diameter	52 mm			
Spectral Range	0.266 – 2.5 μm			
Calibrated spectral range	0.300 – 2.1 µm			
Available Extra Calibrated	2.1 µm - 2.5 µm			
Ranges ^a	2.1 μπι -	'		
Power Noise Level	30mW with anticipation 15 mW without anticipation	30mW with anticipation ^d 15 mW without anticipation ^d		
Typical Rise Time (0 - 95 %)	4 s (with anticipation) 15 s (without anticipation)	5 s (with anticipation)		
Typical sensitivity	0.06 mV/W	50S : 120 mV/W 100 H : 60 mV/W 150 F : 40 mV/W 300 W : 20 mV/W		
Calibration Uncertainty ^e	± 2.	5 %		
Linearity with Power	± 2			
Repeatability (Precision)	± 0.			
Max. Average Power	50S: 100H: 150F: 300W:	100 W 150 W 300 W		
Max. Average Power (1 min.) (cooling : minimum 3 min)	50S : 50 W 100H : 100 W 150F : 150 W 300W : 300 W			
Max. Average Power Density ^b 1.064 μm, 10 W CW	100 kV			
Pulsed Laser Damage Thresholds 1.064 μm, 360 μs, 5 Hz 1.064 μm, 7 ns, single shot 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	Max. Energy Density 300 J/cm² 16 J/cm² 8 J/cm² 6 J/cm² 1 J/cm²	Peak Power Density 830 kW/cm² 2280 MW/cm² 1140 MW/cm² 860 MW/cm² 143 MW/cm²		
Dimension (mm)	50S : 89(H) x 8 100H : 89(H) x 8 150F : 89(H) x 8 300W : 89(H) x	89(W) x 106(D) 39(W) x 116(D)		
Weight (head only)	100H: 0.93 Kg 100H: 0.93 Kg 150F: 1.41 Kg 300W: 0.84 Kg			
Minimum Cooling Flow ^c	1 liter			
Cooling	Heat sink / I			
Recommended load Impedance	> 100 kΩ	10 ΜΩ		
Output Impedance	N. A.	≤ 50 Ω		
Linearity vs beam dimension	± 0.			
Power supply range (VDD)	N. A.	+12 V to +16 V regulated		
Max outpul signal	N. A.	80% of PCB electrical supply		

a The calibrations at 2.1 to 2.5 µm are on special request only and will incur additional charges. Contact a Gentec-EO representative to learn more about this calibration option or get a quote for it.
b See graph at the end of this section.
c Water temperature ≤ 22°C, 1/8 NPT compression fittings for 1/4 inch semi-rigid tube.
d With PCB: Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

^e Including linearity with power

UP55N(M)Hx-	UP55N-40S / 100H -H9	UP55N-40S / 100H -H9	UP60N-40S / 100H -H9		
01 0014(W) 11X	UP55N-300F -H12	UP55N-300F -H12	UP60N-300F -H12		
	UP55N-300DI -H12	UP55N-300DI -H12	UP60N-300DI -H12		
	UP55N-400DI -HD	UP55N-400DI -HD	UP60M-500W -H12		
UP60N(M)Hx-	UP55M-500W -H12	UP55M-500W -H12	UP60M-700W -HD		
	UP55M-700W -HD	UP55M-700W -HD			
	Without PCB	With PCB	Without PCB		
Aperture Diameter	55 mr	n	60 mm		
Spectral Range		190 nm - 20 µm			
Calibrated spectral range ^a		0.248 – 2.1 μm			
Available Extra Calibrated		•			
Ranges b		2.1 μm - 2.5 μm <u>OR</u> 10.6 μm			
· ·······g	With anticipation :	With anticipation :	With anticipation :		
	H9 : 10 mW	H9: 4mW ^e	H9 : 10 mW		
	H12: 30 mW	H12: 30 mW °	H12 : 30 mW		
	HD : 90 mW	HD : 90 mW ^e	HD : 90 mW		
Power Noise Level	Without anticipation	Without anticipation	Without anticipation :		
	H9 : 5 mW	H9: 2mW ^e	H9 : 5mW		
	H12 : 15 mW	H12:15 mW ^e	H12: 15 mW		
	HD : 45 mW	HD: 45 mW ^e	HD : 45 mW		
	110 . 45 1110	110. 43 1110	H9: 11 s (2 s with anticipation)		
	H9: 11 s (2 s with anticipation)	H9: 2 s (with anticipation)			
Typical Rise Time (0 - 95 %)	H12: 18 s (2 s with anticipation)	H12: 3 s (with anticipation)	H12: 18 s (2 s with anticipation)		
, ,	HD: 14 s (2.8 s with anticipation)	HD: 5s (with anticipation)	HD : 14 s (2.8 s with anticipation)		
	. ,	408: 450>\/\\	аниораноп)		
		40S : 150 mV/W			
	H9 : 0.12 mV/W	100H: 60 mV/W	H9 : 0.12 mV/W		
Tomical acceptions		300F: 20 mV/W			
Typical sensitivity	H12: 0.06 mV/W	300DI : 20mV/W	H12: 0.06 mV/W		
	HD : 0.03mV/W	400DI : 15mV/W	HD : 0.03mV/W		
		500W : 15 mV/W			
		700W : 8 mV/W			
Calibration Uncertainty f		± 2.5 %			
Linearity with Power		± 2 %			
Repeatability (Precision)		± 0.5 %			
		40S : 40 W			
		100H : 100 W			
		300F : 300 W			
Max. Average Power		300DI : 300W			
		400DI : 400W			
		500W : 500 W			
		700W : 700 W			
		40S : 80 W			
		100H : 200 W			
Max. Average Power		300F : 300 W			
(1 min.)		300DI : 300W			
(cooling: minimum 3 min)		40001 40014/	300DI : 300W		
İ.	400DI : 400W				
		500W : 500 W			
Max. Average Power Density °		500W : 500 W			
1.064 µm, 10 W CW		500W : 500 W 700W : 700 W 45 kW/cm ²			
1.064 μm, 10 W CW 10.6 μm, 10 W CW		500W : 500 W 700W : 700 W			
1.064 µm, 10 W CW	Max. Energy Density	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ²	Peak Power Density		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz	Max. Energy Density 9 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ²	Peak Power Density 25 kW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds		500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ²			
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz	9 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ²	25 kW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz	9 J/cm² 1.0 J/cm²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ²	25 kW/cm ² 143 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ²	25 kW/cm ² 143 MW/cm ² 86 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm² 14 kW/cm²	25 kW/cm ² 143 MW/cm ² 86 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 14 kW/cm ²	25 kW/cm ² 143 MW/cm ² 86 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 40S: 89(H) × 89(W) × 32(D) 100H: 89(H) × 89(W) × 106(D)	25 kW/cm ² 143 MW/cm ² 86 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 	25 kW/cm ² 143 MW/cm ² 86 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 14 kW/cm ² 100H: 89(H) × 89(W) × 32(D) 100H: 89(H) × 89(W) × 106(D) 300F: 89(H) × 89(W) × 116(D) 300DI: 89(H) × 89(W) × 44(D) 400DI: 89(H) × 89(W) × 44(D)	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 14 kW/cm ² 100H: 89(H) x 89(W) x 32(D) 100H: 89(H) x 89(W) x 106(D) 300F: 89(H) x 89(W) x 116(D) 300DI: 89(H) x 89(W) x 44(D) 400DI: 89(H) x 89(W) x 44(D) 100W / 700W: 89(H) x 89(W) x 40	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 14 kW/cm ² 100H: 89(H) × 89(W) × 32(D) 100H: 89(H) × 89(W) × 106(D) 300F: 89(H) × 89(W) × 116(D) 300DI: 89(H) × 89(W) × 44(D) 400DI: 89(H) × 89(W) × 44(D) W / 700W: 89(H) × 89(W) × 40 40S: 0.62 kg 100H: 0.93 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 μm, 10 W CW 10.6 μm, 10 W CW Pulsed Laser Damage Thresholds 1.064 μm, 360 μs, 5 Hz 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz Dimension (mm)	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 14 kW/cm ² 100H: 89(H) × 89(W) × 32(D) 100H: 89(H) × 89(W) × 106(D) 300F: 89(H) × 89(W) × 116(D) 300DI: 89(H) × 89(W) × 44(D) 40DI: 89(H) × 89(W) × 44(D) W / 700W: 89(H) × 89(W) × 40 40S: 0.62 kg 100H: 0.93 kg 300F: 1.41 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm ² 14 kW/cm ² 14 kW/cm ² 100H: 89(H) x 89(W) x 32(D) 100H: 89(H) x 89(W) x 106(D) 300DI: 89(H) x 89(W) x 416(D) 300DI: 89(H) x 89(W) x 44(D) 400DI: 89(H) x 89(W) x 44(D) W / 700W: 89(H) x 89(W) x 40 100H: 0.93 kg 300F: 1.41 kg 300DI: 1.68 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 μm, 10 W CW 10.6 μm, 10 W CW Pulsed Laser Damage Thresholds 1.064 μm, 360 μs, 5 Hz 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz Dimension (mm)	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm² 14 kW/cm² 14 kW/cm² 100H: 89(H) x 89(W) x 32(D) 100H: 89(H) x 89(W) x 106(D) 300F: 89(H) x 89(W) x 116(D) 300DI: 89(H) x 89(W) x 44(D) 400DI: 89(H) x 89(W) x 44(D) W / 700W: 89(H) x 89(W) x 44(D) 0W / 0.62 kg 100H: 0.93 kg 300F: 1.41 kg 300DI: 1.68 kg 400DI: 1.68 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 μm, 10 W CW 10.6 μm, 10 W CW Pulsed Laser Damage Thresholds 1.064 μm, 360 μs, 5 Hz 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz Dimension (mm)	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm² 14 kW/cm² 14 kW/cm² 100H: 89(H) × 89(W) × 32(D) 100H: 89(H) × 89(W) × 106(D) 300F: 89(H) × 89(W) × 116(D) 300DI: 89(H) × 89(W) × 44(D) 400DI: 89(H) × 89(W) × 44(D) W / 700W: 89(H) × 89(W) × 40 40S: 0.62 kg 100H: 0.93 kg 300F: 1.41 kg 300DI: 1.68 kg 400DI: 1.68 kg 500W: 0.81 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz Dimension (mm) Weight (head only)	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm² 14 kW/cm² 14 kW/cm² 100H: 89(H) x 89(W) x 32(D) 100H: 89(H) x 89(W) x 106(D) 300F: 89(H) x 89(W) x 116(D) 300DI: 89(H) x 89(W) x 44(D) 400DI: 89(H) x 89(W) x 44(D) W / 700W: 89(H) x 89(W) x 40 40S: 0.62 kg 100H: 0.93 kg 300F: 1.41 kg 300DI: 1.68 kg 400DI: 1.68 kg 500W: 0.81 kg 700W: 0.90 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz Dimension (mm) Weight (head only)	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm² 14 kW/cm² 14 kW/cm² 14 kW/cm² 100H: 89(H) x 89(W) x 32(D) 100H: 89(H) x 89(W) x 106(D) 300F: 89(H) x 89(W) x 116(D) 300DI: 89(H) x 89(W) x 44(D) 400DI: 89(H) x 89(W) x 44(D) W / 700W: 89(H) x 89(W) x 40 40S: 0.62 kg 100H: 0.93 kg 300F: 1.41 kg 300DI: 1.68 kg 400DI: 1.68 kg 500W: 0.81 kg 700W: 0.90 kg 1.5 liter/min	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		
1.064 µm, 10 W CW 10.6 µm, 10 W CW Pulsed Laser Damage Thresholds 1.064 µm, 360 µs, 5 Hz 1.064 µm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz Dimension (mm) Weight (head only)	9 J/cm ² 1.0 J/cm ² 0.6 J/cm ² 0.3 J/cm ²	500W: 500 W 700W: 700 W 45 kW/cm² 14 kW/cm² 14 kW/cm² 100H: 89(H) x 89(W) x 32(D) 100H: 89(H) x 89(W) x 106(D) 300F: 89(H) x 89(W) x 116(D) 300DI: 89(H) x 89(W) x 44(D) 400DI: 89(H) x 89(W) x 44(D) W / 700W: 89(H) x 89(W) x 40 40S: 0.62 kg 100H: 0.93 kg 300F: 1.41 kg 300DI: 1.68 kg 400DI: 1.68 kg 500W: 0.81 kg 700W: 0.90 kg	25 kW/cm ² 143 MW/cm ² 86 MW/cm ² 43 MW/cm ²		

Output Impedance	N. A.	≤ 50 Ω	N. A.
Linearity vs beam dimension		± 0.5 %	
Power supply range (VDD)	N. A.	+12 V to +16 V regulated	N. A.
Max outpul signal	N. A.	VDD (supply)-3V, max of 12V	N. A.

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $^{^{\}text{b}}$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and $10.6 \ \mu m$ calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

about these calibration opinions of get a quote for them.

c See graph at the end of this section.

d Water temperature ≤ 22°C, 1/8 NPT compression fittings for ¼ inch semi-rigid tube. For the stainless steel water module, the minimum cooling flow is 1.0 liter/min for power higher than 90 W.

^e Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

f Including linearity with power

LIDSENIAN VA	UP55N- 50S/100H/150F -VR UP55M- 200W -VR	UP55N- 50S/100H/150F -VR UP55M- 200W -VR		
UP55N(M)VR	Without PCB	With PCB		
Aperture Diameter	55	5 mm		
Spectral Range	300 nm – 2.5 μm			
Calibrated spectral range	0.30 – 2.1 µm			
Available Extra Calibrated Ranges ^a	2.1 μm	- 2.5 μm		
Power Noise Level	30mW with anticipation 15 mW without anticipation	30mW with anticipation ^d 15 mW without anticipation ^d		
Typical Rise Time (0 - 95 %)	4 s 50 s (without anticipation)	5 s (with anticipation)		
Typical sensitivity	0.04 mV/W	50S : 120 mV/W 100 H : 60 mV/W 150 F : 40 mV/W 200 W : 30 mV/W		
Calibration Uncertainty ^e	± 2	2.5 %		
Linearity with Power		2 %		
Repeatability (Precision)).5 %		
Max. Average Power	100H 150F	: 50 W : 100 W : 150 W : 200 W		
Max. Average Power (1 min.) (cooling : minimum 3 min)	50S : 50 W 100H : 100 W 150F : 150 W 200W : 200 W			
Max. Average Power Density ^b 1.064 μm, 10 W CW		W/cm ²		
Pulsed Laser Damage Thresholds 1.064 μm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz 266 nm, 7 ns, 10 Hz 1.064 μm, 360 μs, 5 Hz	Max. Energy Density 6 J/cm² 4 J/cm² 1 J/cm² 40 J/cm²	Peak Power Density 860 MW/cm ² 570 MW/cm ² 143 MW/cm ² 111 kW/cm ²		
Dimension (mm)	50S : 89(H) > 100H : 89(H) > 150F : 89(H) >	x 89(W) x 32(D) x 89(W) x 106(D) x 89(W) x 116(D) x 89(W) x 40(D)		
Weight (head only)	50S : 100H 150F :	0.62 Kg : 0.93 Kg : 1.41 Kg : 0.84 Kg		
Minimum Cooling Flow ^c	1 lit	er/min		
Cooling		/ Fan / Water		
Recommended load Impedance	> 100 kΩ	10 ΜΩ		
Output Impedance	N. A.	≤ 50 Ω		
Linearity vs beam dimension		0.5 %		
Power supply range (VDD)	N. A.	+12 V to +16 V regulated		
Max outpul signal	N. A.	VDD (supply)-3V, max of 12V		

^a The calibrations at 2.1 to 2.5 µm are on special request only and will incur additional charges. Contact a Gentec-EO representative to learn more about this calibration option or get a quote for it.

b See graph at the end of this section.

c Water temperature ≤ 22°C, 1/8 NPT compression fittings for ¼ inch semi-rigid tube.

d With PCB: Noise level measured using P-LINK (USB). Noise level is dependant on acquisition system.

e Including linearity with power

UP55C-2.5KW-HD		5KW-HD
Effective Aperture Diameter		mm
	0.19 μm - 20 μm	
Spectral Range Calibrated spectral range ^a		- 2.1 μm
Available Extra Calibrated	0.246 -	- 2. Ι μπι
Ranges b	2.1 μm - 2.5 μm <u>OR</u> 10.6 μm	
Power Noise Level		n anticipation out anticipation
Typical Rise time (0 - 95 %)	3.5 s (25 s with	out anticipation)
Typical sensitivity	8 μ'	V/W
Calibration Uncertainty d	± 2.	5 %
Linearity with Power	±2	2 %
Repeatability (Precision)	± 0.	5 %
Max. Average Power	250	0 W
Max. Average Power Density 1.064 μm, 500W CW 1.064 μm, 1500W CW 1.064 μm, 2500W CW Max. Average Power Density	9.0 kW/cm ² 7.0 kW/cm ² 6.0 kW/cm ²	
10.6μm, 500W CW 10.6 μm, 1500W CW 10.6 μm, 2500W CW	4.5 kW/cm ² 3.5 kW/cm ² 3.0 kW/cm ²	
Pulsed Laser Damage Thresholds 1064 nm, 7 ns, 10 Hz 532 nm, 7 ns, 10 Hz	Max. Energy Density 1.0 J/cm ² 0.6 J/cm ²	Peak Power Density 143 MW/cm² 86 MW/cm²
Dimension (mm)	116(H) x 11	6(W) x 48(D)
Weight (head only)	3.30 kg	
Cooling	Water	
Recommended Cooling Flow ^c	3-4 liter/min	
Recommended load Impedance	100) kΩ
Output Impedance	N.	A.
Linearity vs beam dimension	±1	%
Power supply range (VDD)	N. A.	
Max outpul signal	N.	A.

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $[^]b$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 μm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them. $^\circ$ Water temperature \le 22 $^\circ$ C, 1/8 NPT compression fittings for ½ inch semi-rigid tube.

d Including linearity with power

UP55GHX UP60GHX	UP55G-500F -H12 UP55G-600F -HD Without PCB	UP55G-500F -H12 UP55G-600F -HD With PCB	UP60G-400F- H12 UP60G-500F- HD Without PCB
Aperture Diameter	55 :	mm	60mm
Spectral Range		190 nm - 20 µm	
Calibrated spectral range ^a		0.248 – 2.1 μm	
Available Extra Calibrated Ranges ^b		2.1 μm - 2.5 μm <u>OR</u> 10.6 μm	
Power Noise Level		Inticipation: H12 : 30 mW HD : 9 t anticipation: H12 : 15 mW HD	
Typical Rise Time (0 – 95 %)	H	12 : 16.6 s (3.5 s with anticipation) HD : 14 s (5 s with anticipation)	
Typical sensitivity		H12: 0.06 mV/W HD: 0.03 mV/W	
Calibration Uncertainty d		± 2.5%	
Linearity with Power		± 2%	
Repeatability (Precision)		± 0.5%	
Max. Average Power	H12: { HD: 6	H12 : 400 W HD : 500 W	
Max. Average Power (1 min.)	H12: 5 HD: 6		H12: 400 W HD: 500 W
Max. Average Power Density ^c	-		
1.064 µm, 10 W, CW		45 kW/cm ²	
1.064 µm, 500 W, CW		8 kW/cm ²	
Pulsed Laser Damage Thresholds	Max. Energy Dens	<u>Pe</u>	eak Power Density
1.064 µm, 360 µs, 5 Hz	9 J/cm ²		25 kW/cm ²
1.064 μm, 7 ns, 10 Hz	1.0 J/cm ²		143 MW/cm ²
532 nm, 7 ns, 10 Hz	0.6 J/cm ²		86 MW/cm ²
266 nm, 7 ns, 10 Hz	0.3 J/cm ²		43 MW/cm ²
Dimensions (mm)		120(H) x 120(W) x 135(D)	
Weight (head only)		2.75 kg	
Cooling		Fan	
Recommended load Impedance		> 100 kΩ	
Output Impedance		N. A.	
Linearity vs beam dimension		± 0.5 %	
Power supply range (VDD)	N. A.		
Max outpul signal		N. A.	

^a The traceability at 248 nm is obtained with the help of a traceable reference at 250 nm, since our spectrophotometer has a 4 nm spectral bandwidth at 248 nm.

 $[^]b$ Both options will incur additional charges. It is not possible to have both 2.1 μm to 2.5 μm and 10.6 μm calibration added to a single detector. Contact a Gentec-EO representative to learn more about these calibration options or get a quote for them.

^c See graph at the end of this section. ^d Including linearity with power



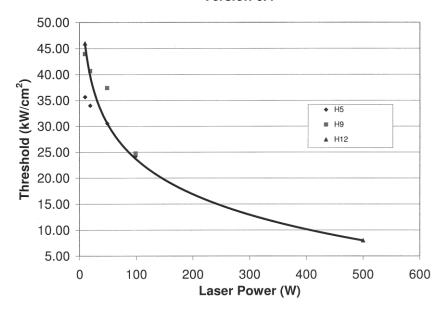


FIG. 1-9 MAX AVERAGE POWER DENSITY FOR UP WITH H-TYPE ABSORBER AT 1.064 μM .

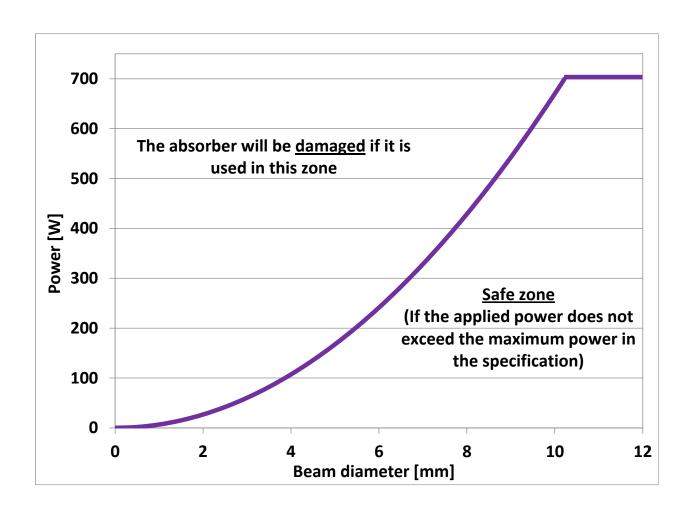


FIG. 1-10 MINIMUM BEAM SIZES FOR UP WITH H-TYPE ABSORBER AT 1.064 μM .

1.4. UP CALORIMETER MODE SPECIFICATIONS

The UP Ultra Series has an optional mode that is called calorimeter mode. It allows you to measure single shot pulse energy. This mode is accessible when you use a UP with a Gentec-EO monitor or with your own data acquisition system. For more information, refer to the monitor's instruction manual or call Customer Support at Gentec-EO, see p. ii, **Contacting Gentec Electro-Optics Inc.**

		XLP(F)	UP12E	UP10P	UP10K	UP16K	UP17P	UP17P
		 H2	 H5	 H5	 H5	 QED	 H5	 W5
Typical sensitivity	mV/J	25 F : 22.5	0.84	2.4	2.4	0.11	0.7	0.2
Power sensitivity / Energy sensitivity	J/W	8	0.63	0.81	0.81	1	0.86	3
Typical rise time in calorimeter mode	ms	1000	150	190	190	185	328	575
Minimum repetition period	sec	16	1.5	2	2	4	4	5
Maximum pulse width	ms	300	50	63	63	61	88	133
Maximum measurable energy ^a	J	5	5	3	3	500	15	200
Noise equivalent energy	mJ	0.012	20	5	5	60	20	20
Accuracy	%	±5	± 5	± 5	±5	± 5	± 5	± 5%

		UP19K H5	UP19K H9	UP19K VR	UP19K W5
Typical sensitivity	mV/ J	0.65	0.23	0.10	0.33
Power sensitivity / Energy sensitivity	J/W	0.99	1	3.4	2
Typical rise time in calorimeter mode	ms	264	264	270	400
Minimum repetition period	sec	4	4	4.5	5
Maximum pulse width	ms	88	88	90	133
Maximum measurable energy ^a	J	15	25	40	200
Noise equivalent energy	mJ	20	60	20	23
Accuracy	%	± 5%	± 5%	± 5	± 5

		UP25N, H9	UP25N, UP25M H12	UP25T H12	UP50N, UP50M W9	UP52N, UP52M QED	UP55N, UP60N H9	UP55N UP55M VR
Typical sensitivity	mV/J	0.14	0.05	0.05	0.020	0.012	0.028	0.010
Power sensitivity / Energy sensitivity	J/W	1.67	2.19	2.19	5.28	4.37	4.25	4.25
Typical rise time in calorimeter mode	ms	370	1300	1300	1400	1200	1300	1300
Minimum repetition period	sec	4.6	11.5	11.5	11.1	9	11.1	11.1
Maximum pulse width	ms	123	390	390	467	371	433	433
Maximum measurable energy ^a	J	40	40	40	500	1000	200	500
Noise equivalent energy	mJ	200	200	200	250	250	250	250
Accuracy	%	± 5	± 5	± 5%	± 5%	± 5%	± 5%	± 5%

		UP55N, UP55M, UP60N, UP60M H12	UP55G, UP60G H12	UP55C HD	UP55M, UP55G, UP60M, UP60G HD
Typical sensitivity	mV/J	0.015	0.013	0.0025	0.008
Power sensitivity / Energy sensitivity	J/W	4.46	4.62	3.19	4.46
Typical rise time in calorimeter mode	ms	1600	1800	855	1600
Minimum repetition period	sec	12	14.3	11	12
Maximum pulse width	ms	430	433	210	430
Maximum measurable energy ^a	٦	200	200	200	200
Noise equivalent energy	mJ	250	250	1300	250
Accuracy	%	± 5	± 5	±5	±5

 a For 1,064 μm ; 360 μs pulses. Higher pulse energy possible when customized for long pulse (ms), lower for short pulses (ns).

1.5. UP POTENTIOMETER POSITIONS

The UP with amplification has 3 holes on top of the detector for the UP12E, UPXXK and the UP25T and on the left side of the detector for the UP25N(M), UP50N(M), UP55N(M) and the UP60N(M) giving access to the potentiometers to adjust the gain, the anticipation and the offset, as shown in figure 1-8.

WARNING: If you are using Gentec-EO calibration, DO NOT change the potentiometer settings because this would invalidate factory calibration.

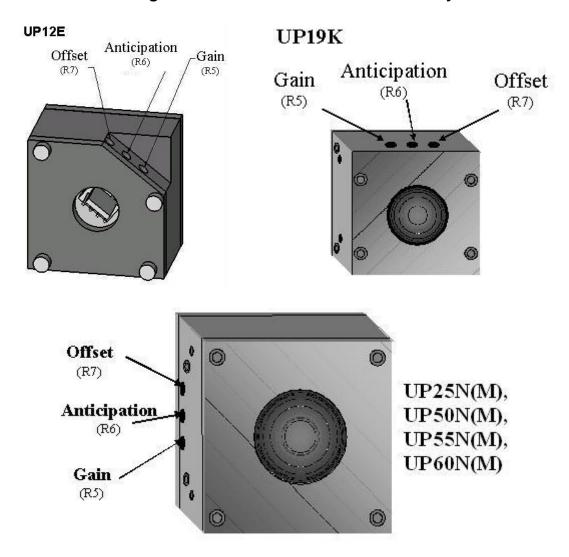


FIG. 1-11 POTENTIOMETER POSITIONS

1.6. USING A CUSTOMER-SUPPLIED HEAT SINK

This is a special case. Standard detectors are calibrated and shipped complete with a Gentec-EO heatsink or back module installed. However, should the customer wish to install an alternative heatsink or back module, the following indications should be followed. This does not apply to the XLP, UP_P, UP_T, UP_M, and UP_G series.

Instructions:

- 1. Required specifications for customer-supplied back module are given in Fig 1-10 through 1-12. Note that tapped holes must be electrically conductive, and that there has to be at least bare spots to allows electrical contact with detector (see point 5.).
- 2. While keeping together the front cover and the central housing, remove the four front screws of the UP detector.
- Discard the back module.
- Apply electrically-conductive silver epoxy on the bare contact zones of the back module (*Tra-Con, Tra-Duct no. BA-2902*). This will ensure proper electrical contact between the new back module and the central housing.
- Apply thermal paste (such as Wakefield Engineering Inc. thermal paste part no. 120-2) on the remainder of back module. This will ensure proper thermal contact with the new back module.
- 6. In the case that both central housing and back module are entirely bare and electrically conducting, a grease that is both thermally and electrically conductive (*Timtronics Black Ice 712*) may be applied, instead of steps 4. and 5.
- 7. Install the new back module onto the detector using the the four original screws. It is strongly advised to apply removable thread locker (*Loctite removable thread locker 242*) on the screws before inserting them. The recommended torque for each of the 4 screws is 6 in.lbs. (70 Ncm).

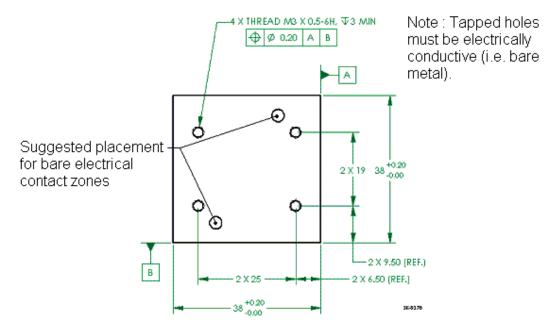


FIG. 1-12 TAPPED HOLE POSITIONS FOR UP12E, WITHOUT PCB

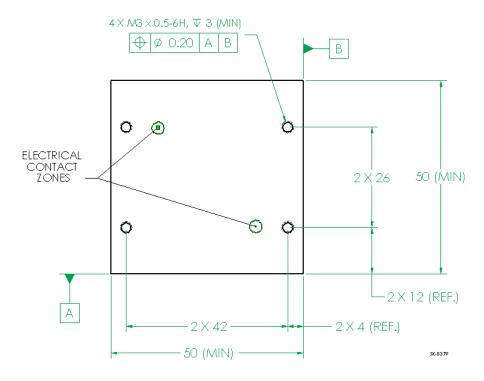


FIG 1-13 TAPPED HOLE POSITIONS FOR UPXXK

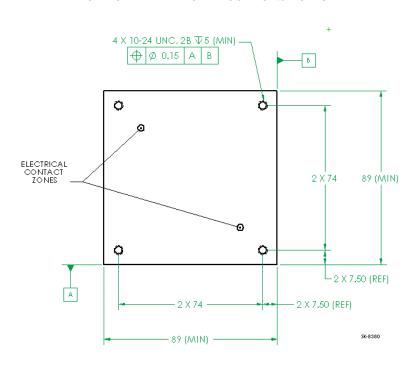


FIG 1-14 TAPPED HOLE POSITIONS FOR UP25N, UP50N(M), UP55N(M), AND UP60(M)

2. OPERATING INSTRUCTIONS

In order to ensure a long lifetime of accurate measurements, it is recommended that UP wattmeters be held within the following ambient conditions stated in the specifications.

For a fan-cooled UP, connect the fan to the proper power supply.

NOTE: The UP55G and UP60G must only be used with the Gentec-EO Power Supply P/N 202199.

For a water-cooled UP, connect the detector head to a an cooling water supply. The water-cooled UP is equipped with $\frac{1}{4}$ " tube fittings.

NOTE: The end of the tube must be cut perpendicular to the tubing; the portion of the outer tubing wall that slips into the fitting must not be deformed or damaged, otherwise the connection will not be water-tight.

To connect the detector head fittings to the water supply tubing, unscrew the two parts of the fitting, push the tubing into the part not connected to the detector until it comes to the end of the fitting; then screw in the two parts of the fitting.

The direction of flow through the head is unimportant. Once you have connected the fittings, check them for leaks. If you find a leak, check to see if the tubes are pushed in far enough and that the tubing has not been damaged.

Verify that the flow rate satisfies the minimum values, as indicated on the specifications pages. A flow rate of at least 1 l/min is recommend for most models. Time variations of water flow rates or water temperature may cause corresponding oscillations in measurements.

To disconnect the detector head fittings, remove the water pressure and drain the water from the tubing. Unscrew the two parts of the fitting and pull out the tubing.

NOTE: Water will usually remain in the detector head after it is disconnected. The detector should be completely dried out with an air flow before being stored. Be careful not to blow the water on yourself or on the detector aperture.

Once appropriate cooling is achieved, the UP is ready to be aligned in the intended optical set-up.

- 1. Remove the power detector cover.
- 2. Align the detector in the optical set-up, using a safe low-powered beam.
- 3. For the most accurate measurements, the beam should be centered on the sensor face. The beam diameter on the sensor should ideally be the same size as the beam diameter of the original calibration, which corresponds to >98% encircled power centered on 50% of the sensor's surface (this complies with the International Electrotechnical Commission standard #1040: "Power and Energy Measuring Detector..."). Refer to calibration certificate for the exact calibration beam diameter.

WARNING: Be careful not to exceed the maximum levels and densities stated in the specifications.

2.1. WITH ANY GENTEC-EO MONITOR

To make a measurement Gentec-EO monitor, continue with the following steps:

- 4. Connect the detector head to the input socket on the monitor (see the monitor's instruction manual).
- 5. Block off the detector head to prevent it from sensing heat from random sources.
- 6. Once the reading is thermally stable, the reading should be set to 0 W with the monitor's Zero (Offset) function (see the monitor's instruction manual).
- 7. Allow the detector head to thermally stabilize before making any subsequent measurement reading.

2.2. WITHOUT A GENTEC-EO MONITOR

To make a measurement without a Gentec-EO monitor, continue with the following steps:

- 4. Let the head thermally stabilize for at least 10 minutes, and set up cooling (if fan- or water-cooled).
- 5. Connect the power head to a precision microvoltmeter, or data acquisition system, with a load impedance that is >100 k Ω (UP without internal circuit board) or with a load impedance >10 M Ω (UP with internal circuit board). Because of the very low voltages at lower power levels for some of these detectors, analog or digital filtration may be required to remove ambient electrical noise.
- 6. Put the power head into the laser beam path (the laser beam must be contained within the sensor area) for about one minute.
- 7. Block off any laser radiation to the detector.
- 8. Switch on the microvoltmeter and adjust its voltage range to the range required for the measurement. To determine the voltage range to be measured, refer to the detector head specifications:

Vout = (expected power) x (calibration sensitivity of power detector)

- 9. Wait until the signal has stabilized (fluctuations representing less than 1% of the voltage level being measured are negligible) then, measure the zero level voltage offset from the detector. Strong fluctuations in the zero level are usually caused by one of the following:
 - · Rapid fluctuations in the rate of water flow.
 - Rapid fluctuations in water temperature.
 - Strong drafts or stray radiation (especially visible when you are taking low power measurements)
 - Ambient electrical noise (should be filtered out).
- 10. Apply the laser beam to the power head.
- 11. Wait until the signal has stabilized (between one to three minutes for optimum measurements), then measure the voltage output from the detector (refer to specifications pages for individual head 0-95% non anticipated response times).
- 12. The measured power is calculated as follows:

Measured power[W] = (output voltage[V] - zero level voltage[V]) / calibration sensitivity[V/W] = 1000 x (Vout[mV] - Vzero level[mV]) / calibration sensitivity[mV/W]

2.3. SAFETY OPERATION NOTES

Diffusive surfaces

When using the UP with a coating H, W, and VR be aware of the diffused back reflection:

- H and W: ~ 5-15%
- VR: ~ 40-45%

As on any diffusive surface, the light on the sensor coating is scattered more or less uniformly as a Lambertian diffuser. It is recommended to use the head with a black protective sleeve. This will limit wide-angled diffused reflections.

Detector temperature while in operation

During usage, detectors can become hot enough to cause burns.

3. DAMAGE TO THE OPTICAL ABSORBER MATERIAL

Damage to the optical absorber material is usually caused by exceeding the manufacturer's specifications, such as:

- Incident Average Power Density
- Incident Pulse Energy Density

Refer to the specifications pages for the Ultra Series UP power head specifications. Damage may also be caused if the absorber surface is contaminated. A slight discoloration of the coating does not affect the calibration.

In any case, the beam's incident area should not be less than 10% of the detector's aperture. Please contact Gentec-EO to make measurements with such smaller beams.

In the event of significant damage to the coating, the Ultra Series UP sensors can be recoated. Contact your local Gentec-EO representative for information on repair and recalibration. See p. ii **Contacting Gentec Electro-Optics Inc.**

4. DECLARATION OF CONFORMITY

Application of Council Directive(s): 2014/30/EU EMC Directive

 ϵ

Manufacturer's Name:

Manufacturer's Address:

Gentec Electro Optics, Inc.

445 St-Jean Baptiste, suite 160
(Québec), Canada G2E 5N7

Representative's Name:

Representative's Address:

Laser Component S.A.S

45 bis Route des Gardes

92190 Meudon (France)

Type of Equipment: Laser Power/Energy Meter

Model No.: UP, XLP series

Year of test & manufacture: 2016

Standard(s) to which Conformity is declared: EN 61326-1: 2006 Emission generic standard

Standard	Description	Performance Criteria
CISPR 11 :2009 A1 :2010	Industrial, scientific and medical equipment – Radio-frequency disturbance characteristics – Limits and methods of measurement	Class A
EN 61000-4-2 2009	Electromagnetic compatibility (EMC) – Part 4-2: Testing and measurement techniques- Electrostatic discharge.	Class B
EN61000-4-3 2006+A2:2010	Electromagnetic compatibility (EMC) – Part 4-3: Testing and measurement techniques- Radiated, Radio Frequency, electromagnetic field immunity test.	Class A
EN61000-4-4 2012	Electromagnetic compatibility (EMC) – Part 4-4: Testing and measurement techniques- Electrical fast transient/burst immunity test.	Class B
EN 61000-4-5 2006	Electromagnetic compatibility (EMC) – Part 4-5: Testing and measurement techniques- Surge immunity test.	Class B
EN 61000-4-6 2013	Electromagnetic compatibility (EMC) – Part 4-6: Testing and measurements techniques- Immunity to conducted Radio Frequency.	Class A
EN 61000-4-11 2004	Electromagnetic compatibility (EMC) – Part 4-11: Testing and measurement techniques- Voltage dips, short interruptions and voltage variations immunity tests. Voltage dips:	
	0% during 1 cycle 40% during 10 cycles 70% during 25 cycles	Class B Class B Class C
	Short interruptions: 0% during 250 cyles	Class C

EN 61000-3-2:2006	Electromagnetic compatibility (EMC) - Part 3-2: Limits - Limits	Class A
+A1:2009	for harmonic current emissions (equipment input current <=	
+A1.2009	16 A per phase)	

I, the undersigned, hereby declare that the equipment specified above conforms to the above Directive(s) and Standard(s)

Place: Quebec (Quebec)
Date: July 14 2016

(President)

5. UKCA DECLARATION OF CONFORMITY

Application of Council Directive(s): 2014/30/EU EMC Directive

CA

Manufacturer's Name: Gentec Electro Optics, Inc.

Manufacturer's Address: 445 St-Jean Baptiste, suite 160

(Québec), Canada G2E 5N7

Representative's Name: Laser Component S.A.S Representative's Address: 45 bis Route des Gardes 92190 Meudon (France)

Type of Equipment: Laser Power/Energy Meter

Model No.: UP, XLP series

Year of test & manufacture: 2016

Standard(s) to which Conformity is declared: EN 61326-1: 2006 Emission generic standard

Standard	Description	Performance Criteria
CISPR 11 :2009 A1 :2010	Industrial, scientific and medical equipment – Radio-frequency disturbance characteristics – Limits and methods of measurement	Class A
EN 61000-4-2 2009	Electromagnetic compatibility (EMC) – Part 4-2: Testing and measurement techniques- Electrostatic discharge.	Class B
EN61000-4-3 2006+A2:2010	Electromagnetic compatibility (EMC) – Part 4-3: Testing and measurement techniques- Radiated, Radio Frequency, electromagnetic field immunity test.	Class A
EN61000-4-4 2012	Electromagnetic compatibility (EMC) – Part 4-4: Testing and measurement techniques- Electrical fast transient/burst immunity test.	Class B
EN 61000-4-5 2006	Electromagnetic compatibility (EMC) – Part 4-5: Testing and measurement techniques- Surge immunity test.	Class B
EN 61000-4-6 2013	Electromagnetic compatibility (EMC) – Part 4-6: Testing and measurements techniques- Immunity to conducted Radio Frequency.	Class A
EN 61000-4-11 2004	Electromagnetic compatibility (EMC) – Part 4-11: Testing and measurement techniques- Voltage dips, short interruptions and voltage variations immunity tests. Voltage dips:	
	0% during 1 cycle	Class B
	40% during 10 cycles	Class B
	70% during 25 cycles Short interruptions:	Class C
	0% during 250 cyles	Class C

EN 61000-3-2:2006	Electromagnetic compatibility (EMC) - Part 3-2: Limits - Limits	Class A
+A1:2009	for harmonic current emissions (equipment input current <=	
+A1.2009	16 A per phase)	

I, the undersigned, hereby declare that the equipment specified above conforms to the above Directive(s) and Standard(s)

Place: Quebec (Quebec)
Date: December 02, 2021

(President)

APPENDIX A: WEEE DIRECTIVE

1.1 Recycling and separation procedure for WEEE directive 2002/96/EC:

This section is used by the recycling center when the detector reaches its end of life. Breaking the calibration seal or opening the monitor will void the detector warranty.

The complete Detector contains

- 1 Detector with wires or DB-15.
- 1 instruction manual
- 1 calibration certificate
- 1 Electronic PCB (Integra option)
- 1 Plastic enclosure (Integra option)

1.2 Separation:

Paper: Manual and certificate

Wires: Cable Detector.

Printed circuit board: inside the Detector (for -MT, -MA, -BT and -CP version only) or DB-15, no need to separate (less then 10 cm²). Inside the integra enclosure, no need to separate (less then 10 cm²).

Aluminum: Detector casing. Plastic: Integra enclosure.

APPENDIX B: USING THE XLP12 WITH THE XLP12 FILTER

The XLP12 filter features ease of installation and removal. To use an XLP12 series wattmeter (@ any wavelength) with the XLP12 filter, the user must calibrate the assembly using the following procedure:

<u>Step 1:</u> Set up the XLP12 wattmeter without the filter to measure the power of your laser. Adjust the sensitivity of the wattmeter to your working wavelength. Verify that the power level is below the detector's damage threshold and that the laser has a good stablity.

<u>Step 2:</u> Warm up the detector by applying power to it for a few minutes. This will reduce thermal bias.

<u>Step 3:</u> Measure the power level (without the filter). To reduce random uncertainty, we recommend taking the average of 5 distinct measurements.

<u>Step 4:</u> Install the filter. Without changing the laser settings, measure the power level by averaging the same number of distinct measurements as in Step 3. All laser settings remain identical as in Step 3, including beam size and position on detector.

<u>Step 5:</u> Repeat the first measurement (Step 3) to verify that there hasn't been any change during the procedure that would invalidate the calibration. A difference that is larger than the uncertainty of your measurement means that something in the laser or environment changed. You may add this to your \pm uncertainty when using the filter or you may try stabilizing the laser and environment and repeat from <u>Step 3</u>.

The correction multiplier for the Duo (rev 2.0) and the Solo will be given by:

$$T_f = \frac{\text{Reading without attenuator}}{\text{Reading with attenuator}} \text{(no units)}$$

The correction factor for the Duo (prior to rev 2.0) will be:

$$F_s = \frac{100}{T_f}(\%)$$

Now use calibration factor F_s for the filter when using it at the wavelength established in <u>Step 1</u>.

XLP12 Filter			
Spectral Range	280 nm – 1.36 μm		
Typical Transmittance (@ 1.064 µm)	93 %		
Typical Reflectance (@ 1.064 µm)	7 %		
Dimensions (installed in own mount and XLP12, ext. Ø x thickness)	1.2 " x 1/3 "		

FIG. 1-15 XLP12 FILTER SPECIFICATIONS

APPENDIX C: USING THE XLP12 WITH AN OPTICAL FIBER ADAPTOR

When fitted with an appropriate adaptor, such as Gentec-EO's FC Optical Fiber Connector, the XLP12 can be used to measure the output of an optical fiber. When using an optical fiber adaptor, it is the user's responsibility to ensure that the entire output of the fiber is incident upon the detector's absorbing surface. Figure 1-10 and the following inequation are provided as a guide to verify this.

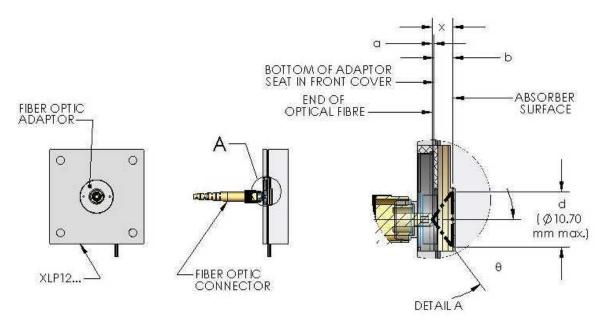


FIG. 1-16 USING AN OPTICAL FIBER ADAPTOR

For the XLP12, the distance in mm between the absorbing surface and the adaptor seat is $b = 3.75 \pm 0.5$. The diameter in mm corresponding to 80% of the absorbing surface (80% is a common value for allowing sufficient margin to avoid edge effects) is d = 10.7. The acceptance angle θ of the fiber is specific to the user's fiber, as is the value of a, the distance in mm between the end of the fiber and the interface between the adaptor and its seat on the detector. This value can be measured once the user's fiber is connected to the fiber adaptor (a typical value may be a = 0.2 mm). Once known, the values θ and a can be entered in the following inequation:

$$(a+4)\tan\theta < 5.35$$
,

Where, 5.35 is d/2. If the inequation is verified, then it is safe to consider that the light cone, having a height x = a + b and a maximum diameter d, exiting the fiber is entirely incident on 80% of the measuring surface of the detector.



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- Office No. 101, EXL111 building, Takinogawa, Kita-ku, Tokyo 114-0023, JAPAN